Celanese
The chemistry inside innovation™

ZENITE® 55201

Liquid Crystal Polymer

Zenite® ZE55201 is a 50% mineral/glass fiber reinforced liquid crystal polymer for injection molding. and It is specifically suitable for applications requiring ultra flatness.

Product information

Resin Identification	LCP-(GF+MD)50		ISO 1043
Part Marking Code	>LCP-(GF+MD)50<		ISO 11469

Rheological properties

Molding shrinkage, parallel	0.1	%	ISO 294-4, 2577
Molding shrinkage, normal	0.3	%	ISO 294-4, 2577

Typical mechanical properties

Tensile modulus	2.29E6	psi	ISO 527-1/-2
Tensile stress at break, 5mm/min	12800	psi	ISO 527-1/-2
Tensile strain at break, 5mm/min	1.4	%	ISO 527-1/-2
Flexural modulus	1.81E6	psi	ISO 178
Flexural strength	23900	psi	ISO 178
Compressive stress at 1% strain	3090	psi	ISO 604
Charpy notched impact strength, 23°C	1.71	ftlb/in²	ISO 179/1eA

Thermal properties

Melting temperature, 10°C/min	635	°F	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	554	°F	ISO 75-1/-2
Temperature of deflection under load, 0.45 MPa	572	°F	ISO 75-1/-2
Coefficient of linear thermal expansion (CLTE), parallel	0.08	E-4/°F	ISO 11359-1/-2
Coefficient of linear thermal expansion (CLTE), normal	0.15	E-4/°F	ISO 11359-1/-2
Thermal conductivity of melt	0.4	W/(m K)	ISO 22007-2
Specific heat capacity of melt	1500	J/(kg K)	ISO 22007-4

Flammability

Burning Behav. at 1.5mm nom. thickn.	V-0	class	IEC 60695-11-10
Thickness tested	0.0591	in	IEC 60695-11-10
Burning Behav. at thickness h	V-0	class	IEC 60695-11-10
Thickness tested	0.0315	in	IEC 60695-11-10
UL recognition	yes		UL 94
Oxygen index	41	%	ISO 4589-1/-2

Electrical properties

Relative permittivity, 1MHz	4		IEC 62631-2-1
Relative permittivity, 2GHz	4.51[OT, 1]		IEC 61189-2-721
Relative permittivity, 10GHz	4.47[OT]		IEC 61189-2-721
Dissipation factor, 100Hz	310	E-4	IEC 62631-2-1
Dissipation factor, 1MHz	310	E-4	IEC 62631-2-1
Dissipation factor, 2GHz	49[OT, 1]	E-4	IEC 61189-2-721

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Dissipation factor, 10GHz	38[OT]	E-4	IEC 61189-2-721
Volume resistivity	>1E13	Ohm.m	IEC 62631-3-1
Surface resistivity	>1E15	Ohm	IEC 62631-3-2
Electric strength	940	kV/in	IEC 60243-1
Comparative tracking index	175		IEC 60112

[OT]: One time tested

[1]: Black color, tested at 1.9GHz

Physical/Other properties

Density	0.0668	lb/in³	ISO 1183
Density of melt	101	lb/ft³	

Injection

Drying Recommended	yes	
Drying Temperature	302	°F
Drying Time, Dehumidified Dryer	4 - 6	h
Processing Moisture Content	≤0.01	%
Melt Temperature Optimum	644	°F
Min. melt temperature	626	°F
Max. melt temperature	662	°F
Max. screw tangential speed	0.2 - 0.3	m/s
Mold Temperature Optimum	212	°F
Min. mold temperature	176	°F
Max. mold temperature	248	°F
Back pressure	435	psi
Ejection temperature	549	°F

Characteristics

Processing	Injection Molding
Special characteristics	Flame retardant, Heat stabilized or stable to heat, High Flow, Low Warpage, Lead-free soldering resistant

Additional information

Injection molding

Preprocessing

Drying Temperature = 140 °C
Drying Time, Dehumidified Dryer = 4-6h
Processing Moisture Content = <0.01 %

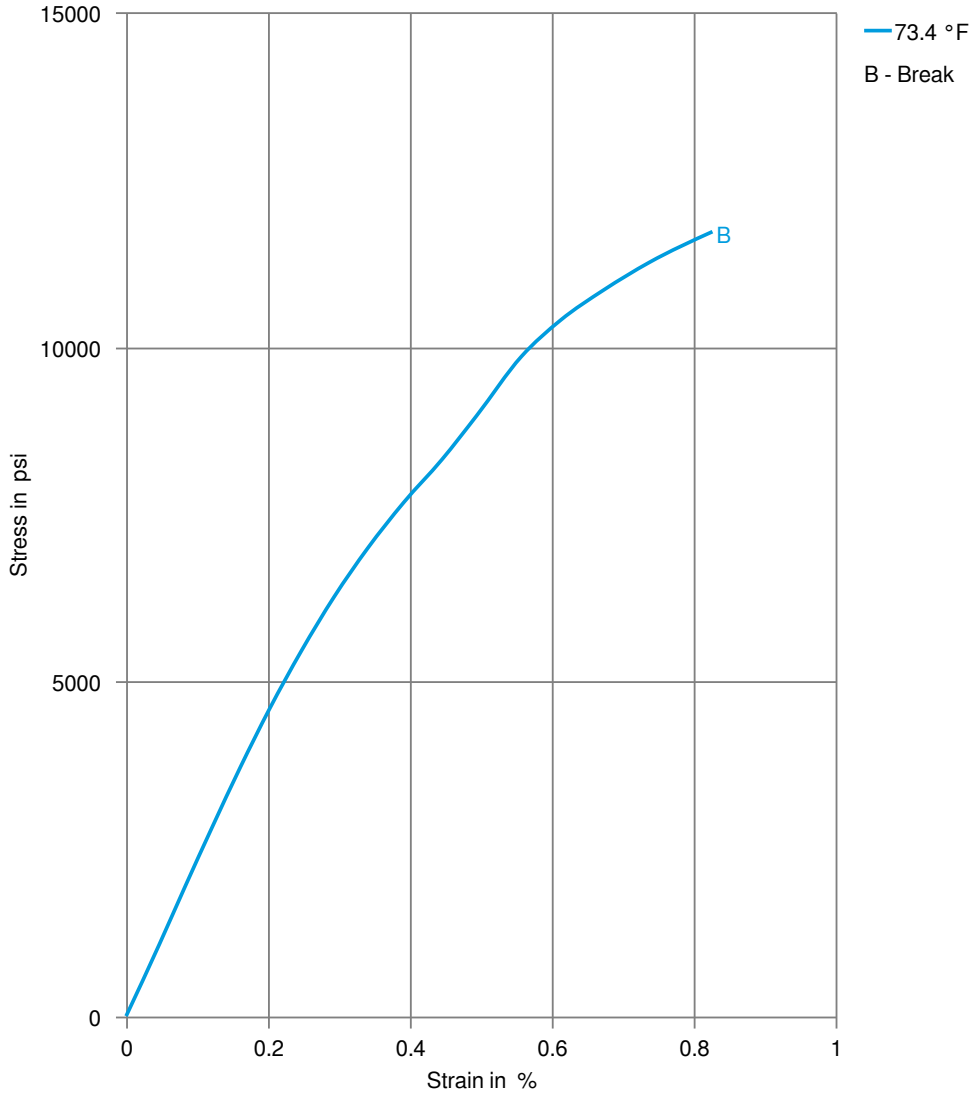
Processing

Melt Temperature Range = 330-350 °C
Melt Temperature Optimum = 335 °C
Mold Temperature Optimum = 80 °C
Mold Temperature Range = 40-150 °C

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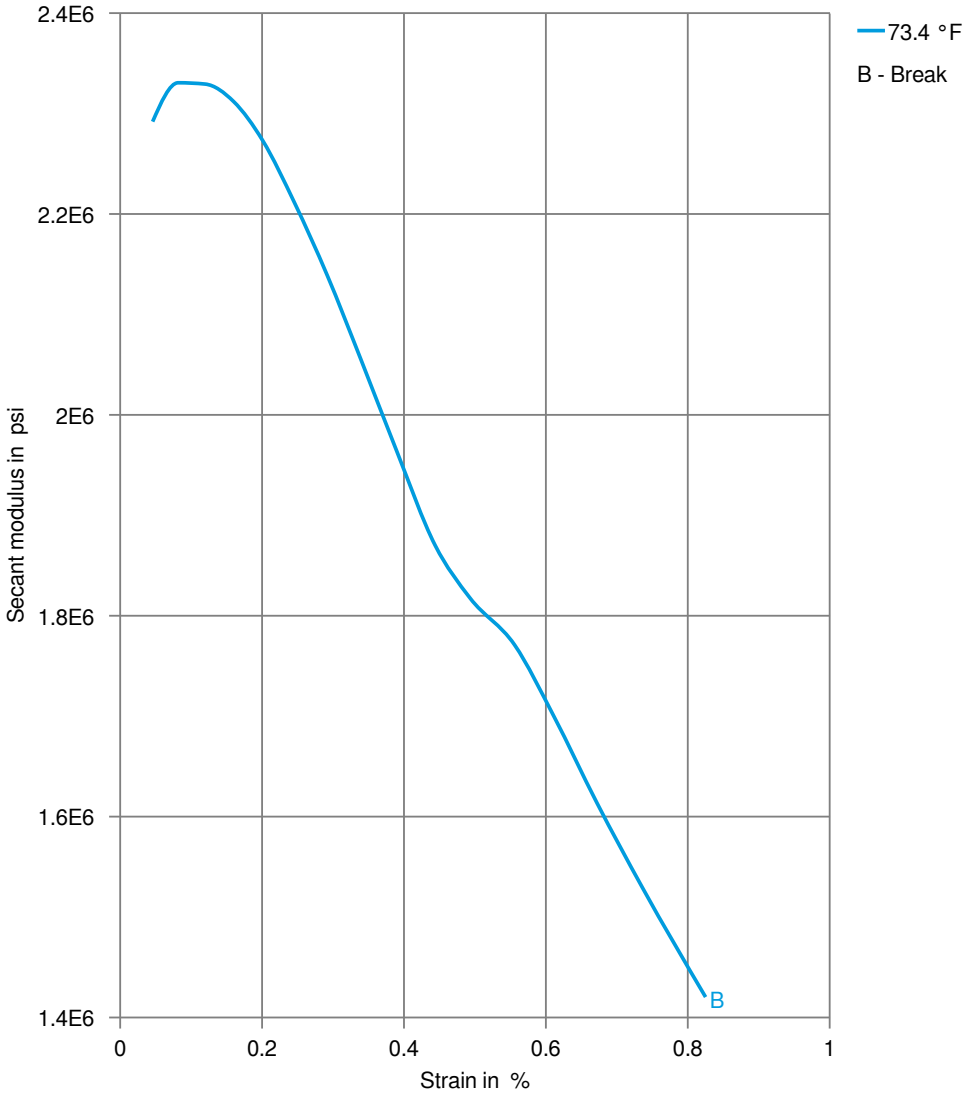
Stress-strain



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Secant modulus-strain



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